

Description

The IRF7341TRPBF uses advanced trench technology

to provide excellent R_{DS(ON)}, low gate charge and

operation with gate voltages as low as 2.5V. This

device is suitable for use as a

Battery protection or in other Switching application.



SOP-8

General Features

 $V_{DS} = 60V I_{D} = 6.5 A$

 $R_{DS(ON)}$ < 36m Ω @ V_{GS} =10 V

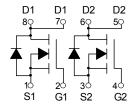
 $R_{DS(ON)}$ < 48m Ω @ V_{GS} =4.5V

Application

Battery protection

Load switch

Uninterruptible power supply



Dual N-Channel MOSFET

Package Marking and Ordering Information

| Product ID | Pack | Marking | Qty(PCS) |
|--------------|-------|---------------|----------|
| IRF7341TRPBF | SOP-8 | 4828 XXX YYYY | 3000 |

Absolute Maximum Ratings@Tj=25°C(unless otherwise specified)

| | <u> </u> | | |
|--------------------------------------|---|-------------|-------|
| Symbol | Parameter | Rating | Units |
| V _{DS} | Drain-Source Voltage | 60 | V |
| V _{GS} | Gate-Source Voltage | <u>+</u> 20 | V |
| I _D @T _A =25°C | Drain Current, V _{GS} @ 4.5V ³ | 6.5 | А |
| I _D @T _A =70°C | Drain Current, V _{GS} @ 4.5V ³ | 5 | А |
| Ірм | Pulsed Drain Current ¹ | 30 | А |
| P _D @T _A =25°C | Total Power Dissipation | 2.1 | W |
| Тѕтс | Storage Temperature Range | -55 to 150 | °C |
| TJ | Operating Junction Temperature Range | -55 to 150 | °C |
| Rthj-a | Maximum Thermal Resistance, Junction- ambient ³ | 60 | °C/W |



Electrical Characteristics (T_A=25 ℃ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|------------------------------------|---------------------|--|---|------|------|------|
| Off Characteristics | | | • | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250μA | V _{GS} =0V I _D =250μA 60 69 | | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =60V,V _{GS} =0V | - | - | 1 | μA |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±20V,V _{DS} =0V | - | - | ±100 | nA |
| On Characteristics (Note 3) | | | | • | • | |
| Gate Threshold Voltage | $V_{GS(th)}$ | V _{DS} =V _{GS} ,I _D =250μA | 1.0 | 1.4 | 2.0 | V |
| Danier Courses On Otata Basistana | R _{DS(ON)} | V _{GS} =10V, I _D =6A | | 32 | 36 | mΩ |
| Drain-Source On-State Resistance | | V _{GS} =4.5V, I _D =4A | | 34 | 48 | mΩ |
| Forward Transconductance | g FS | V _{DS} =5V,I _D =6A | | 20 | - | S |
| Dynamic Characteristics (Note4) | 1 | | 1 | I. | | |
| Input Capacitance | C _{lss} | V 05VV 0V | | 1920 | | PF |
| Output Capacitance | Coss | V _{DS} =25V,V _{GS} =0V, | | 155 | | PF |
| Reverse Transfer Capacitance | C _{rss} | F=1.0MHz | | 116 | | PF |
| Switching Characteristics (Note 4) | | | | • | • | |
| Turn-on Delay Time | t _{d(on)} | | - | 8 | - | nS |
| Turn-on Rise Time | t _r | V_{DS} =30V, R_L =4.7 Ω V_{GS} =10V, R_{GEN} =3 Ω | - | 5 | - | nS |
| Turn-Off Delay Time | t _{d(off)} | | - | 29 | - | nS |
| Turn-Off Fall Time | t _f | | - | 6 | - | nS |
| Total Gate Charge | Qg | V 20VI 04 | - | 50 | - | nC |
| Gate-Source Charge | Q_{gs} | V_{DS} =30V, I_{D} =6A, V_{GS} =10V | - | 8 | - | nC |
| Gate-Drain Charge | Q_{gd} | V _{GS} =10 V | - | 16 | - | nC |
| Drain-Source Diode Characteristic | cs | | | | • | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V,I _S =6A | - | - | 1.2 | V |
| Diode Forward Current (Note 2) | I _S | | - | - | 7 | Α |
| Reverse Recovery Time | t _{rr} | TJ = 25°C, I _F =7A | - | 35 | - | nS |
| Reverse Recovery Charge | Qrr | $di/dt = 100A/\mu s^{(Note3)}$ | - | 43 | - | nC |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD) | | | | |

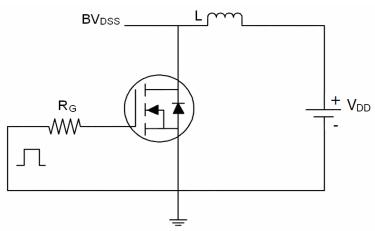
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

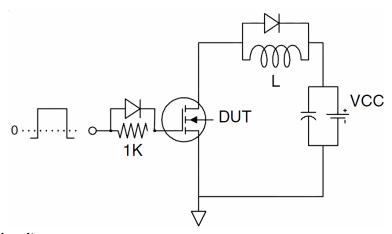


Test Circuit

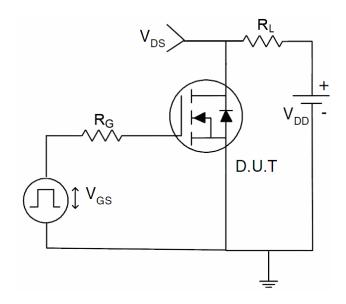
1) E_{AS} test Circuits



2) Gate charge test Circuit

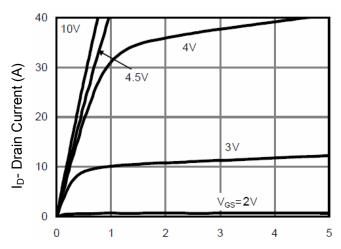


3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics

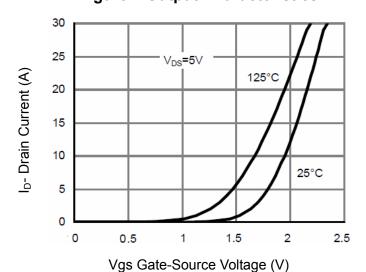


Figure 2 Transfer Characteristics

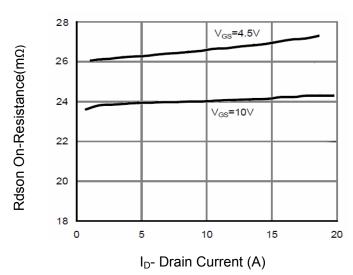
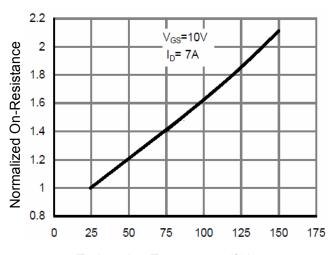


Figure 3 Rdson- Drain Current



 T_J -Junction Temperature(${}^{\circ}C$)

Figure 4 Rdson-JunctionTemperature

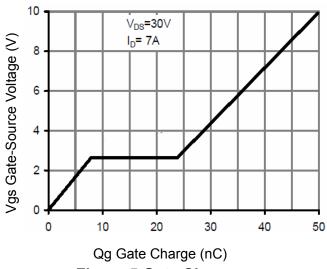


Figure 5 Gate Charge

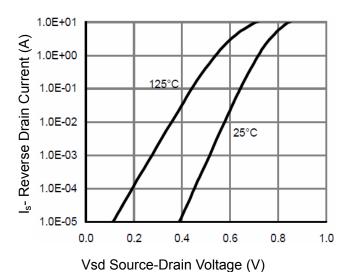


Figure 6 Source- Drain Diode Forward

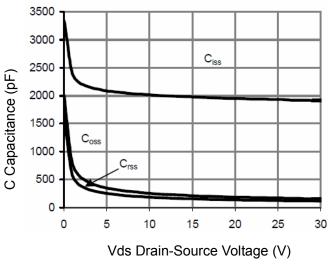


Figure 7 Capacitance vs Vds

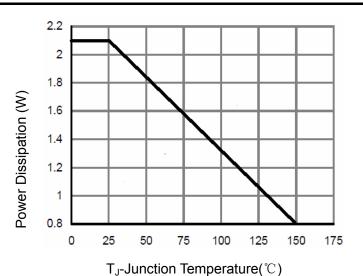


Figure 9 Power De-rating

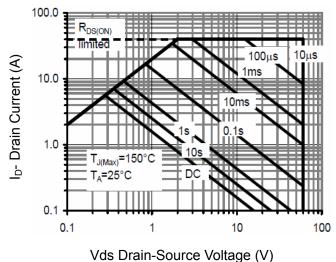


Figure 8 Safe Operation Area

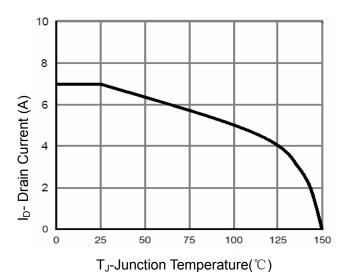


Figure 10 Current De-rating

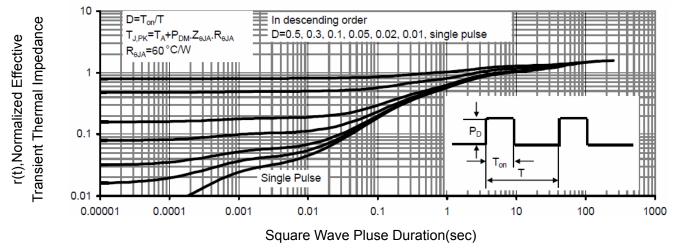
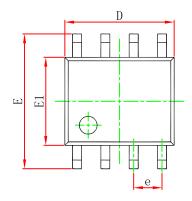
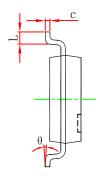


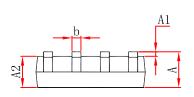
Figure 11 Normalized Maximum Transient Thermal Impedance



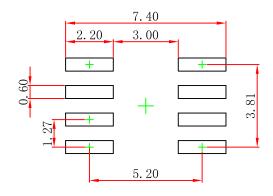
SOP-8 Package Outline Dimensions







| Symbol | Dimensions In Millimeters | | Dimensions In Inches | | |
|--------|---------------------------|--------|----------------------|--------|--|
| | Min | Max | Min | Max | |
| A | 1.350 | 1.750 | 0.053 | 0.069 | |
| A1 | 0.100 | 0.250 | 0.004 | 0.010 | |
| A2 | 1.350 | 1.550 | 0.053 | 0.061 | |
| b | 0.330 | 0.510 | 0.013 | 0.020 | |
| с | 0. 170 | 0. 250 | 0.007 | 0.010 | |
| D | 4.800 | 5.000 | 0.189 | 0.197 | |
| e | 1.270 (BSC) | | 0.050 (BSC) | | |
| Е | 5.800 | 6. 200 | 0. 228 | 0. 244 | |
| E1 | 3.800 | 4.000 | 0.150 | 0. 157 | |
| L | 0.400 | 1.270 | 0.016 | 0.050 | |
| θ | 0° | 8° | 0° | 8° | |



- Note: 1.Controlling dimension:in millimeters.
- 2.General tolerance:±0.05mm.
 3.The pad layout is for reference purposes only.

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